

C16-EC-105

## 6032

## BOARD DIPLOMA EXAMINATION, (C-16) MARCH/APRIL—2018 DECE—FIRST YEAR EXAMINATION

ELECTRONIC DEVICES AND POWER SUPPLIES

Time: 3 hours ]

[ Total Marks : 80

3×10=30

## PART—A

**Instructions** : (1) Answer **all** questions.

- (2) Each question carries three marks.
- (3) Answers should be brief and straight to the point and shall not exceed *five* simple sentences.
- **1.** Find the color code for the resistance of 2.2 kilo ohms with 5% tolerance.
- **2.** List the applications of capacitors.
- **3.** Classify the types of inductors.
- **4.** Sketch the ISI symbols of SPST, SPDT, DPDT and DPST switches.
- 5. What are the advantages of PCBS?
- 6. Distinguish between *N*-type and *P*-type semiconductors.
- 7. Sketch the V-I characters of Zener diode.
- 8. Draw the circuits for three transistor configurations.

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- 9. Give the symbols for the following :
  - (a) P-channel JFET
  - (b) N-channel JFET

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- (c) P-channel MOSFET
- **10.** Draw the circuit of half-wave rectifier with input and output waveforms.

PART—B	10×5=50
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Instructions : (1) Answer any five questions.

- (2) Each question carries **ten** marks.
- (3) Answers should be comprehensive and the criterion for valuation is the content but not the length of the answer.

(a)	Classify the resistors.	4
(b)	With neat sketch, describe the working of rheostat, and state its applications.	6
(a)	List the steps involved in screen-printing in making PCBS.	5
(b)	Explain surface mount technology (SMT) and list its uses.	5
(a)	Distinguish between intrinsic semiconductor and extrinsic semiconductor.	4
(b)	Distinguish among conductors, semiconductors and insulators.	6
(a)	List the applications of diode.	4
(b)	Explain potential barrier of <i>P-N</i> junction diode using energy band diagram.	6
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	<ul> <li>(b)</li> <li>(a)</li> <li>(b)</li> <li>(a)</li> <li>(b)</li> <li>(a)</li> <li>(b)</li> </ul>	<ul> <li>(a) List the steps involved in screen-printing in making PCBS.</li> <li>(b) Explain surface mount technology (SMT) and list its uses.</li> <li>(a) Distinguish between intrinsic semiconductor and extrinsic semiconductor.</li> <li>(b) Distinguish among conductors, semiconductors and insulators.</li> <li>(a) List the applications of diode.</li> <li>(b) Explain potential barrier of <i>P-N</i> junction diode using energy band diagram.</li> </ul>

15.	(a) List the specifications of <i>P-N</i> junction diode and state their importance.	5
	(b) Define alpha and beta. Give the relationship between them.	5
16.	Sketch the input and output characteristics of CE configuration and indicate the active, saturation and cutoff regions.	10
17.	With neat sketch, explain the construction and working of depletion type $n$ -channel MOSFET.	10
18.	(a) Draw and describe the working of full-wave bridge rectifier with input and output waveforms.	8
	(b) Draw the circuit of simple Zener voltage regulator.	2

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